



# Product Change Notification

**Change Notification #:** 114243 - 03  
**Change Title:** Intel® Ethernet Converged Network Adapter X520-DA2 Series, Product Codes: E10G42BTDA, MM# 900139, E10G42BTDABLK, MM# 927249, E10G42BTDAG1P5, MM# 901227, E10G42BTDAPG1P5, MM# 927067, EX520DA2G2P5, MM# 913120  
PCN 114243-03, Product Material, Label Updates to Bracket Design, Regulatory Mark and Labels  
**Reason for Revision: Modify text in label combination to include FCC.**

**Date of Publication:** June 02, 2016

**Key Characteristics of the Change:**  
Product Material, Label

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Jan 25, 2016
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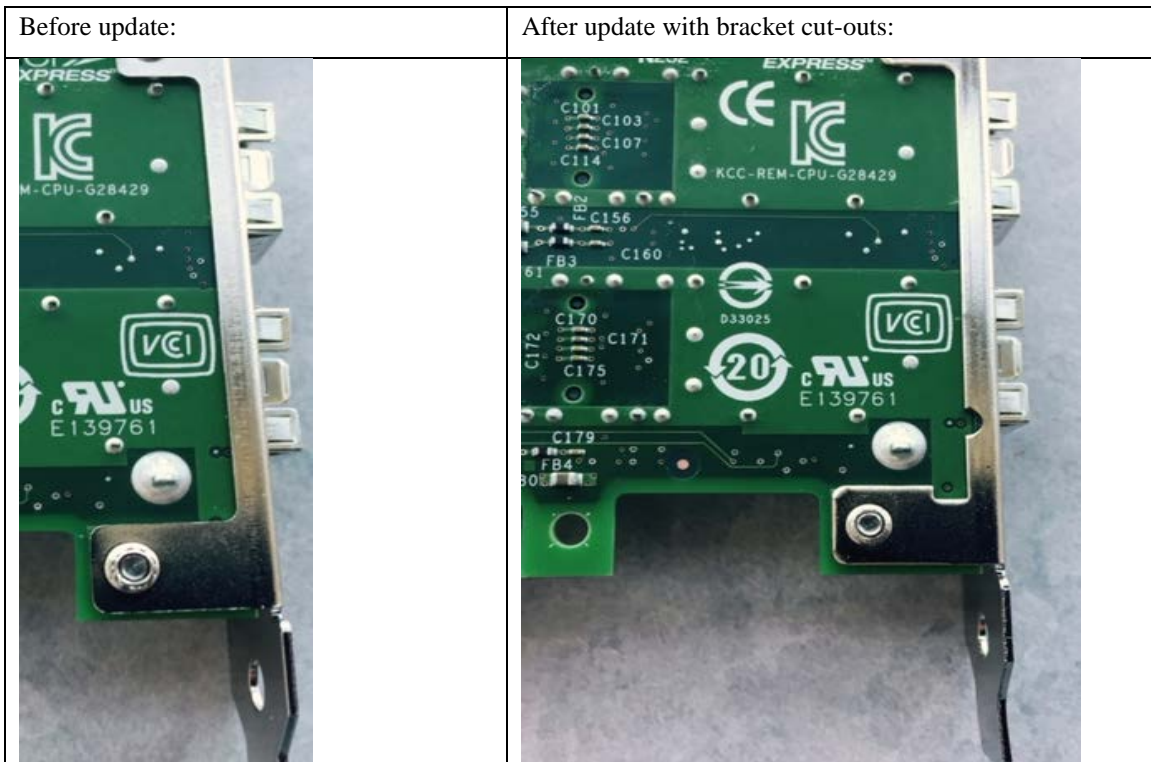
## Description of Change to the Customer:

**Reason for Revision: Modify text in label combination to include FCC.**

Intel® Ethernet Converged Network Adapter X520-DA2 Series, Product Codes: E10G42BTDA, MM# 900139, E10G42BTDABLK, MM# 927249, E10G42BTDAG1P5, MM# 901227, E10G42BTDAPG1P5, MM# 927067, EX520DA2G2P5, MM# 913120 will undergo the following changes:

1. Product codes - E10G42BTDABLK, E10G42BTDAG1P5, E10G42BTDAPG1P5, EX520DA2G2P5:

To improve the bracket clearance with via pads, the bracket has been re-designed with 2 notches. The part number on the Standard height bracket will change from E33052-003 to E33052-004. The part number on the Low Profile bracket will change from E33054-002 to E33054-003



2. All product codes - E10G42BTDABLK, E10G42BTDAG1P5, E10G42BTDAPG1P5, EX520DA2G2P5, E10G42BTDA:

A. Australia Regulatory Mark Change

- The Australian Communications and Media Authority's (ACMA) labeling arrangements to reflect regulatory compliance changed on 1 March 2013, to be phased in over a three-year transition period. Products shipping March 1, 2016 need to be labeled with the "RCM" mark.
- Per ACMA requirements, Intel will be changing the C-Tick regulatory mark on all products to the "RCM" mark.
- Mark will be updated in two ways, depending on how the current C-Tick mark is already on products:
  - If C-Tick mark is currently on PCB silkscreen, Intel will apply a label with RCM mark to cover current mark.
  - If C-Tick mark is currently printed on a label, Intel will replace the mark so labels will be printed with new mark.
- See for picture of "C-Tick" versus "RCM" mark

C-Tick Mark

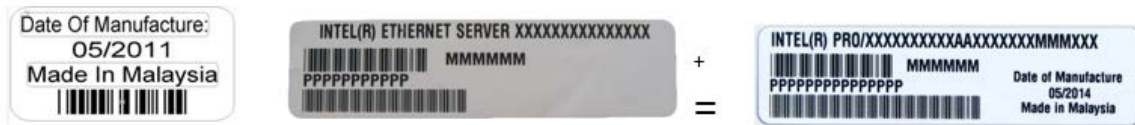



RCM Mark



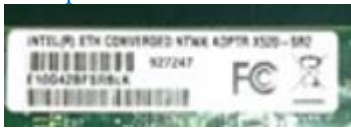
- B. Where applicable this will affect OEMG and Retail NICs.  
Combining of KCC and/or the FCC, and/or Date of Manufacture label with the product ID label to minimize labels on the board. In addition we'll be taking the opportunity to:

Remove	Reg label	KCC_DOM or FCC
Edit	PID label	Product ID
To Include	PID label	Product ID + DOM or Product ID + DOM + other



The WEEE label  maybe incorporated into the Intel branded PID.

Example of PID Label with FCC and WEEE.



### Customer Impact of Change and Recommended Action:

Customers can expect to receive mixed inventory until current inventory levels are depleted. Intel anticipates no functional impact to customer but encourages customer to understand the changes. Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

### Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
E10G42BTDA	900139	E68797-006	E68793-006	E68797-007	E68793-007
E10G42BTDAG1P5	901227	E64797-005	E66560-006	E64797-006	E66560-007
EX520DA2G2P5	913120	G24942-004	G24940-005	G24942-005	G24940-006
E10G42BTDAPG1P5	927067	G83820-001	G83821-001	G83820-002	G83821-002
E10G42BTDABLK	927249	G90047-001	E68793-006	G90047-002	E68793-007

### PCN Revision History:

Date of Revision:	Revision Number:	Reason:
December 21, 2015	00	Originally Published PCN
December 29, 2015	01	Correcting the Year on Ready to Receive
January 25, 2016	02	Removing Optical Transceiver Update
June 2, 2016	03	Modify text in label combination to include FCC.



# Product Change Notification

## 114243 - 03

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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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